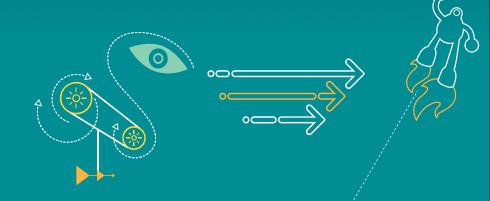
高通8937功耗温升优化技术期刊-20160427

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Revision History

Revision	Date	Description
Α	April 27, 2016	Initial version

Checklist

- Generic Power Debug Document
- Generic Power Measurement Checklist
- Generic Power Debug Tips
- MSM8937 Power Document
- MSM8937 CR/Patches Checklist
- MSM8937 Tips

Generic Power Debug Document

Document # (文档编号)	Document Description (文档描述)
80-P0955-1SC (中文版) 80-P0955-1 (英文版)	Power Debug Guide with Simplified Chinese 很详细的功耗debug中文手册,里面有各种case debug的步骤,以及如何 来抓取各种log。功耗优化的必读宝典
80-NA157-246	LA Power Optimization 很详细的调试功耗如何抓log,用工具的文档。有各种场景如何抓log的介绍
80-NT616-1	Multimedia Power Debugging Case 有各种多媒体case的功耗调试手段介绍
80-NP961-1	Camera Power Debug Guide Camera功耗调试手册
80-NT384-1	PerfLock API Overview PerfLock接口的介绍
80-P1818-1EC	QUALCOMM ONDEVICE POWER DASHBOARD TEST GUIDE 客户机功耗测试指导手册
80-NT614-1	Android_Power_Basics_Power_Feature_Overview
80-P0956-1	Android_Power_Overview
80-P0958-1	Master_Reference_Document_Power

Generic Power Measurement Checklist

- 在测试功耗之前,请检查下面的这些基本项
- Use perf_defconfig instead defconfig
 - Remove "Debug" features
 - Double check if "CORESIGHT" config is removed
 - Double check if "CONFIG_MSM_DEBUG_LAR_UNLOCK" config is removed
- Disable UART console
 - Especially for smart panel
- Remove unnecessary debug log with high frequency
- Remove on-device logging tools

Generic Power Debug Tips --- How To Check RBSC Power

Use IR camera to scan board's hot spot if RBSC current is high;

当RBSC高的时候可以使用IR Camera看看热点在哪里,这样可以确定是哪个硬件模块没有进入休眠。这个对某个大模块没有进入休眠很有帮助。比如Audio Codec

- Check if some clocks prevent system from going to VDD_MIN from AP side
 运行下面的命令,然后从kernel的dmesg中能看到AP休眠的时候,还有那些clock是enabled的。例如最常见NFC配置错误的时候,bb_clk2_pin在suspend之前没有被disable,导致系统进入不了VDD_MIN
 adb shell "echo 1 > /sys/kernel/debug/clk/debug_suspend
- Hardware break down

硬件break down对于调试RBSC非常有用。通过焊掉不同器件能够知道到底是哪个器件有漏电。比如拔屏,焊掉NFC模块,Audio Codec模块,各种sensors等等。

- Compare HW difference between OEM device and Qualcomm reference board
 比如LCD, Touch Screen, Finger Print, NFC, Audio Codec, Sensors。最经常有问题的比如NFC, Finger Print.
- 对于有Finger Print的设备,如果Finger Print驱动request了CXO,那么系统就不能进入VDD_MIN.这样RBSC就会高些
- Dump only clock via JTAG
 如果不希望通过JTAG传递太多数据,可以只dump clock,这样可以看出哪个clock阻止系统进入休眠。
- For more details, pls refer to doc 80-P0955-1SC, chapter 3.1.

更多细节,请参考文档80-P0955-1SC的"3.1 底电流"

Generic Power Debug Tips --- How To Check MP3 Power

Identify the MP3 playback mode

Compress offload /Tunnel mode: Decoding on ADSP,下面是命令 adb shell setprop audio.offload.disable 0
Non-Offload/Nontunnel mode: Decoding on CPU,下面是命令 adb shell setprop audio.offload.disable 1

Check if there is 3rd party sound effect lib such as Dolby
 如果有第三方的音效处理算法,系统功耗肯定会比高通参考数据高。为了方便比较,可以先disable第三方算法,然后和参考平台进行比较

Check is there any Hi-Fi function enabled
 可以重点关注Hi-Fi PA的功耗情况。同时看看有没有Hi-Fi bypass mode用来方便做对比测试

For more details, pls refer to doc 80-P0955-1SC, chapter 3.4.

更多细节,请参考文档80-P0955-1SC的"3.4 MP3播放"

Generic Power Debug Tips --- How To Check Static Display Power

Check Static Display with Android Native UI

这样可以排除由于产品本身的UI引起的功耗增加。Native UI case功耗正常以后再切换到产品定制UI上来。很多时候我们可以根据波形来进行对比。比如看看定制化UI的功耗波形是否有周期性的peak之类。

Check if Touch Screen consumes more power

当Touch Screen产生了更多中断的时候, Static Display这种case会有更好的功耗。Touch Screen本身firmware是否有优化空间也是考虑之一。需要和Touch Screen厂家沟通以确认。

Check if auto backlight adjustment feature is enabled
 为了能更好对比功耗数据,做测试的时候需要disable自动背光调整功能

For more details, pls refer to doc 80-P0955-1SC, chapter 3.3.

更多细节,请参考文档80-P0955-1SC的"3.3 静态显示"

Generic Power Debug Tips --- How To Check Camera Power

Disable all unnecessary logs

Camera应用场景的时候因为log过多会导致系统功耗上升很多。要减少不必要log输出,或者直接disable LogD。

Balance Performance and Power

比如对于fps,可以低于30fps以取得更低功耗。需要找Camera Vendor提供更低帧率的设置对于sensor output,可以采用最低的sensor output resolution来满足实际场景需要,比如1080P video record的时候sensor就不用输出Full Size,而是最接近1080P的sensor output.

Balance Performance and Power

比如对于fps,可以低于30fps以取得更低功耗。需要找Camera Vendor提供更低帧率的设置对于sensor output,可以采用最低的sensor output resolution来满足实际场景需要,比如1080P video record的时候sensor就不用输出Full Size

Get basic power data with all features disabled, such as OIS, ASD

第一步先disable各种feature来得到一个最低功耗。因为各种feature功耗多少是可以采用叠加方式的。把最简单的case调好了后面就好调了。调试简单case的时候最好避免其他因素的干扰。

• For more details, pls refer to doc 80-P0955-1SC, chapter 4.17, 4.18 and 4.19.

更多细节,请参考文档80-P0955-1SC的4.17 摄像头预览调试, 4.18 摄像头功率优化技术 4.19 视频录制功率 优化技术 "

Generic Power Debug Tips --- How To Check Trex Power

- Disable thermal engine before power data collection
- Optimize Display Porch Values
 这样可以优化功耗
- Get ftrace log for analysis
 可以重点focus在DDR和CPU的频率和利用率上

Generic Power Debug Tips --- DoU (Days of Usage)

- Brightness should be adjust to a reasonable value when do apple to apple comparing with the target HW;
 不同硬件的同一亮度实际的背光功耗也可能有区别,这部分在做DoU比较的时候要弄清楚
- Thermal facts should be taken into account
 不同的thermal config会对DoU结果有影响

MSM8937 Power Document

Document # (文档编号)	Document Description (文档描述)
80-P2468-7	MSM8937_LA_Current_Consumption_Data 包括各种应用场景下的功耗breakdown数据
80-P2485-4	MSM8937_System_Power_Overview
80-NU154-10	MSM8956_MSM8976_MSM8937_RPM_Overview_and_Debug
80-P2468-1	MSM8937 DEVICE SPECIFICATION
80-P2067-1	MSM8937/17 MSM8953 Technical Conference

Checklist --- CR/Patches (NEW)

N means No Impact - means Side Effect

+ means Good Impact

CR	Fix	Patch	Perf	Power	Stability	Comment
1 4471113	Power regression of MP3/MP4 on CS load.		Ν	+		The CR fixes the corner case in PM_QOS code.
980223	Disable the ktime backtrace in kernel PM suspend flow.		N	N	N	Impact of CR#936509(optimize the suspend/idle latency).
no	changes from 64mA to	https://android.googlesour ce.com/platform/system/b t/+/d0aa6cc53abaf122a24 26c20691ccfa025ca7369 %5E%21/#F0	Ν	+	N	Maintain the new framework of blacklist devices for absolute volume.
924291	With some camera operation, RBSC becomes ~12mA afterwards.		Z	+	N	Specific G sensor(LSM6DS3) driver blocks ADSP sleep, even sensor is actually disabled.

Checklist --- CR/Patches (NEW)

N means No Impact - means Side Effect

+ means Good Impact

CR	Fix	Patch	Perf	Power	Stability	Comment
986194	Current Consumption in RF5425 is higher than expected, need init PA to OFF after UE bootup.		N	+	N	Abnormal case, PA consumes 70~80mA. Without RF5425, this CR would be not included.
1	With some camera operation, system standby would become ~40mA		N	+	N	Timestamp between gyro sensor and camera is not expected. Camera exit function blocked by Cam_MctBus deadlock.

Android Power profile

问题:

about measuring power values(/frameworks/base/core/res/res/xml/power_profile.xml), QC doesn't have any power for each cpu frequency, even others like WIFI scan/active power...

建议:

不支持, 需自行测试得到. 无法衡量其准确度.

Google官网:

- https://source.android.com/devices/tech/power/index.html
- https://source.android.com/devices/tech/power/values.html

Config for HW without NXP NFC (important)

问题:

HW without NXP NFC, there may be a chance that static image display see ~6mA power increase. Actually other CPU active scenarios will show the similar symptom.

解决:

请关闭TARGET_USES_NQ_NFC和 CONFIG_NFC_NQ, Smartcard service可根据需要自行决定开关.

- TARGET_USES_NQ_NFC := false
- #in device/qcom/msm8937_64/msm8937_64.mk <32bit or 64bit to choose>
- \kernel\arch\arm64\configs\<device config file>
- To disable: (by default switched ON in 8937)
- Comment or delete this flag.
- #CONFIG_NFC_NQ=y
- TARGET_ENABLE_PROPRIETARY_SMARTCARD_SERVICE := true
- #in vendor/qcom/proprietary/common/msm89XX/BoardConfigVendor.mk.

MSM8937 Tips